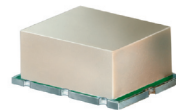


X2 Frequency Multiplier

50Ω Output 20 to 2000 MHz

SYK-2R+
SYK-2R



CASE STYLE: TTT167

Maximum Ratings

Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
Absolute Max. Power	+21dBm
Permanent damage may occur if any of these limits are exceeded.	

Pin Connections

INPUT	2
OUTPUT	1
GROUND	4,5,6
NOT USED	3

Features

- wideband, 20 to 2000 MHz
- low conversion loss, 10.5 dB typ.

Applications

- synthesizers
- local oscillators

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Electrical Specifications at 25°C

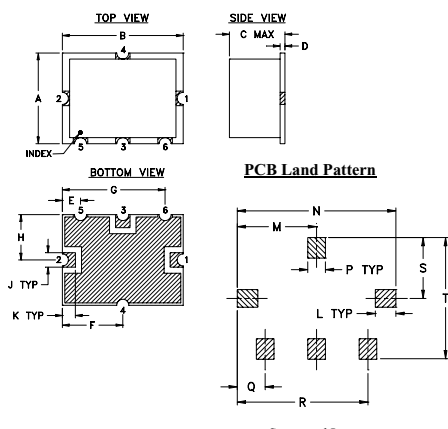
MULTIPLICATION FACTOR	FREQUENCY (MHz)		INPUT POWER (dBm)		CONVERSION LOSS (dB)		*HARMONIC OUTPUT (dBc)					
	F1	F2	Min. Max.		Typ. Max.		F1		F3		F4	
2	Input	Output					Typ.	Min.	Typ.	Min.	Typ.	Min.
	10-500	20-1000	12 16		10.5 14.0		35	25	42	25	20	10
	500-1000	1000-2000	12 16		11.5 16.0		32	20	37	20	20	10

* Harmonics of input frequency below the power level of F2.

Typical Performance Data 25°C

Input Frequency (MHz)	Conversion Loss (dB) F2	Harmonic Output (-dBc)		
		F1	F3	F4
10.00	10.70	42.42	46.82	16.42
35.00	10.18	53.30	62.08	17.36
65.00	10.10	53.60	56.32	18.56
100.00	10.39	51.67	53.85	17.49
250.00	10.46	42.71	50.14	18.94
500.00	10.81	36.79	42.16	16.36
750.00	11.14	28.68	36.07	18.60
850.00	11.78	26.29	31.08	17.82
950.00	11.83	25.85	29.19	19.43
1000.00	11.61	25.54	30.74	21.25

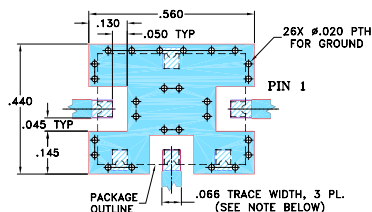
Outline Drawing



Outline Dimensions (inch/mm)

A	B	C	D	E	F	G	H	J	K
.38	.50	.23	.020	.075	.250	.425	.187	.050	.050
9.65	12.70	5.84	0.51	1.91	6.35	10.80	4.75	1.27	1.27
L	M	N	P	Q	R	S	T	wt.	
.070	.270	.540	.060	.095	.445	.208	.415	grams	
1.78	6.86	13.72	1.52	2.41	11.30	5.28	10.54	0.8	

Demo Board MCL P/N: TB-12 Suggested PCB Layout (PL-079)



NOTE:

1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. THE USE OF SOLDER MASK OVER THE GROUND AREA UNDER THE UNIT AS SHOWN IS RECOMMENDED TO PREVENT POTENTIAL SHORTING. IF USER CHOOSES TO EXPOSE METAL UNDER THE ENTIRE UNIT GROUND PAD FOR IMPROVED GROUNDING, IT IS RECOMMENDED A SOLDER MASK DAM BE APPLIED AROUND EACH GROUND PAD TO ENSURE FILLET AND CONNECTION AT GROUND PADS.
 3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER), SEE NOTE 2.
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



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REV. D
M157741
SYK-2R
AD/AM
160823
Page 1 of 1

Frequency Multiplier (Doubler)

SYK-2R+

Typical Performance Data

FREQUENCY (MHz)				CONVERSION LOSS (dB)	HARMONIC OUTPUT* (-dBc)		
X 1 OUTPUT	X 2 OUTPUT	X 3 OUTPUT	X 4 OUTPUT	X 2 OUTPUT	X 1 OUTPUT	X 3 OUTPUT	X 4 OUTPUT
10	20	30	40	10.70	42.42	46.82	16.42
35	70	105	140	10.18	53.30	62.08	17.36
65	130	195	260	10.10	53.60	56.32	18.56
100	200	300	400	10.39	51.67	53.85	17.49
250	500	750	1000	10.46	42.71	50.14	18.94
500	1000	1500	2000	10.81	36.79	42.16	16.36
750	1500	2250	3000	11.14	28.68	36.07	18.60
850	1700	2550	3400	11.78	26.29	31.08	17.82
950	1900	2850	3800	11.83	25.85	29.19	19.43
1000	2000	3000	4000	11.61	25.54	30.74	21.25

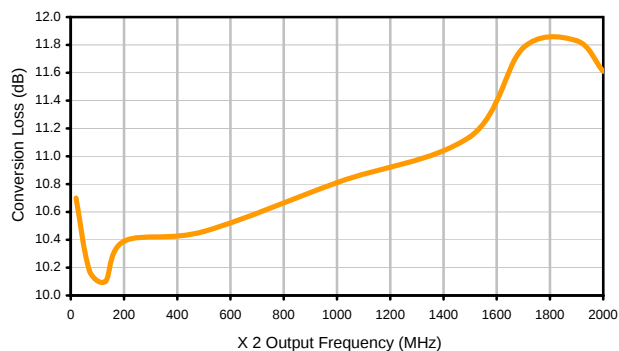
*Harmonic Output below power level of X 2 Output .

Frequency Multiplier (Doubler)

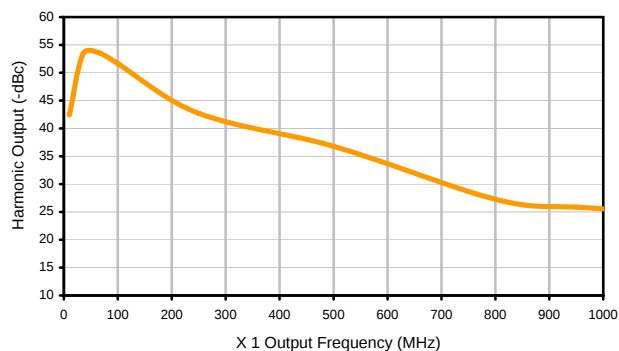
SYK-2R+

Typical Performance Curves

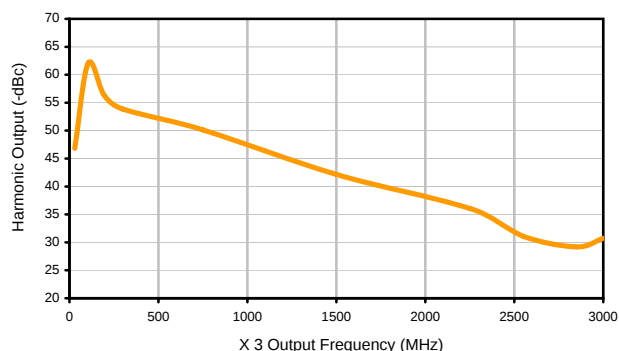
Conversion Loss X 2 Output



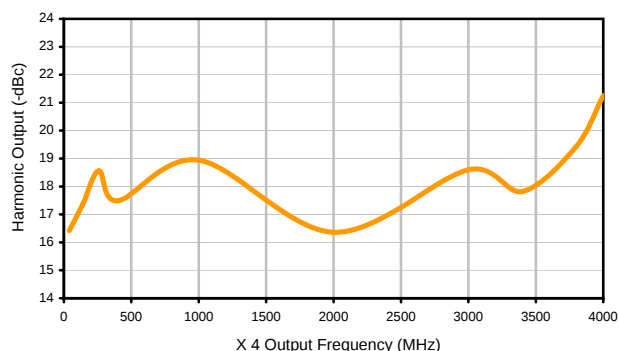
Harmonic X 1 Output



Harmonic X 3 Output

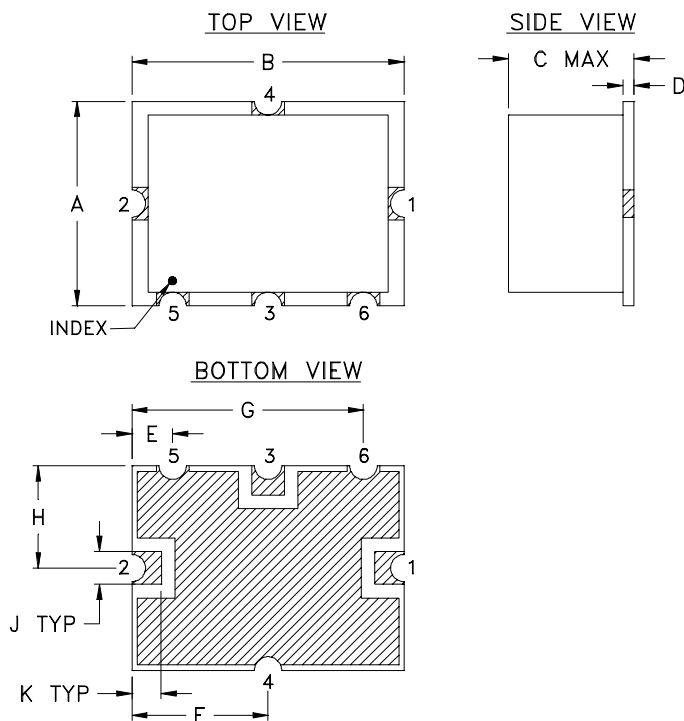


Harmonic X 4 Output

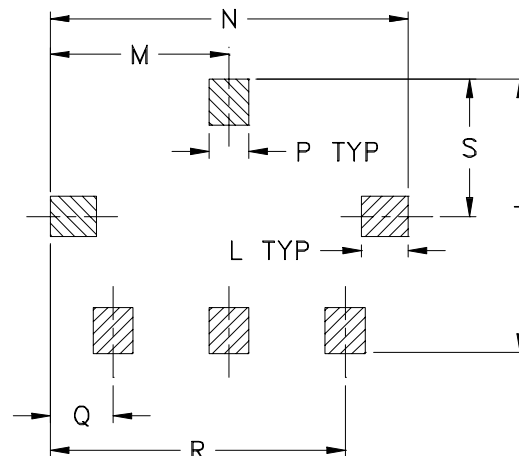


Outline Dimensions

TTT166
TTT167



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N
TTT166	.38 (9.65)	.50 (12.70)	.15 (3.81)	.020 (0.51)	.075 (1.91)	.250 (6.35)	.425 (10.80)	.187 (4.75)	.050 (1.27)	.050 (1.27)	.070 (1.78)	.270 (6.86)	.540 (13.72)
TTT167			.23 (5.84)										

CASE #	P	Q	R	S	T	WT. GRAM
TTT166	.060 (1.52)	.095 (2.41)	.445 (11.30)	.208 (5.28)	.415 (10.54)	.8
TTT167						.8

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Note:

- Case material: Plastic.
- Base material: Printed wiring laminate.
- Termination finish:
 - For RoHS Case Styles: 3-5 μ inch (.08-.13 microns) Gold over 120-240 μ inch (3.05-6.10 microns) Nickel plate. All models, (+) suffix.
 - For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F12



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
24	12	7	Small quantity standards (see note)	10
				20
				50
				100
				200
		13	Standard	500

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



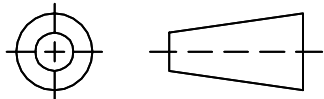
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P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

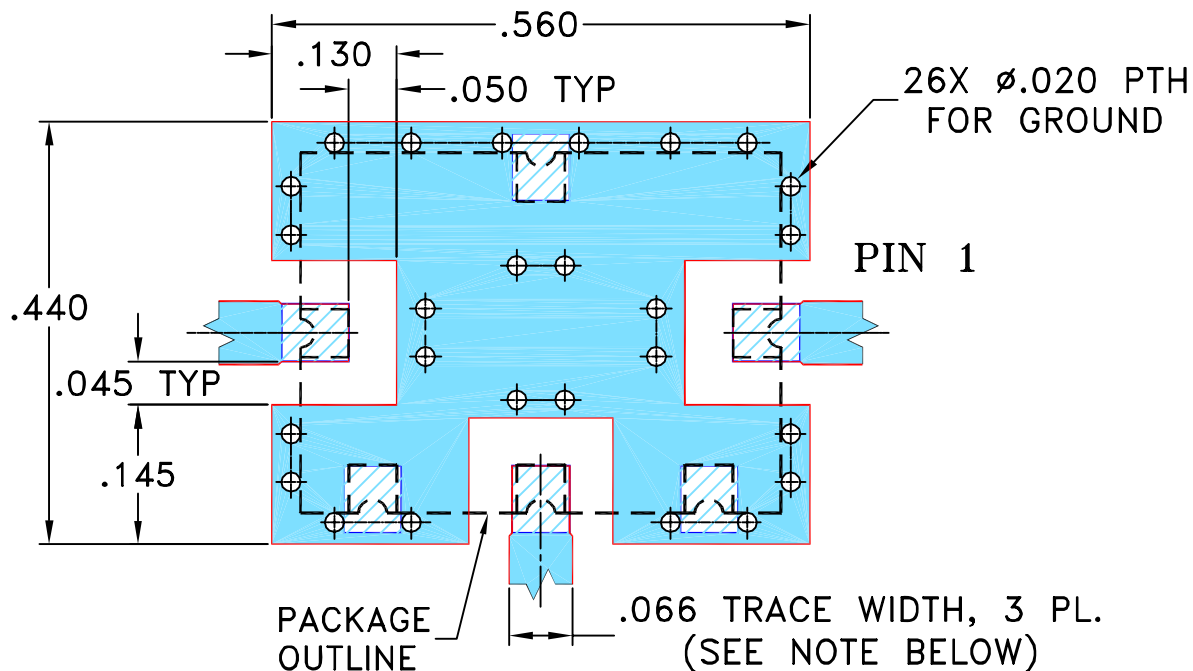
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
A	M86762	ADDED CONNECTIONS "lp & lq"	05/23/03	MMG	WL
B	M94598	ADDED CONNECTION "hk"	10/08/04	MMG	HY
C	M102713	UPDATED NOTES & DESCRIPTION	01/14/06	GF	IL
D	M132989	UPDATED NOTE 2	08/24/11	GF	DJ

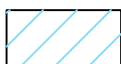
**SUGGESTED MOUNTING CONFIGURATION FOR
TTT166/167 CASE STYLE, "hk"/"lp"/"lq"
"x"/"ck"/"ec" PIN CONNECTIONS**

**NOTE:**

1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .030" $\pm$.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. THE USE OF SOLDER MASK OVER THE GROUND AREA UNDER THE UNIT AS SHOWN IS RECOMMENDED TO PREVENT POTENTIAL SHORTING. IF USER CHOOSES TO EXPOSE METAL UNDER THE ENTIRE UNIT GROUND PAD FOR IMPROVED GROUNDING, IT IS RECOMMENDED A SOLDER MASK DAM BE APPLIED AROUND EACH GROUND PAD TO ENSURE FILLET AND CONNECTION AT GROUND PADS.
3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER), SEE NOTE 2.



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

GF

03/18/03

CHECKED

IL

04/15/03

APPROVED

DJ

04/15/03



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, hk/lp/lq/x/ck/ec, TTT166/167,
SYM/HJK/SYAS/SYPD, TB-12

SIZE
A

CODE IDENT
15542

DRAWING NO:
98-PL-079

REV:
D

FILE: 98PL079

SCALE: 5:1

SHEET: 1 OF 1

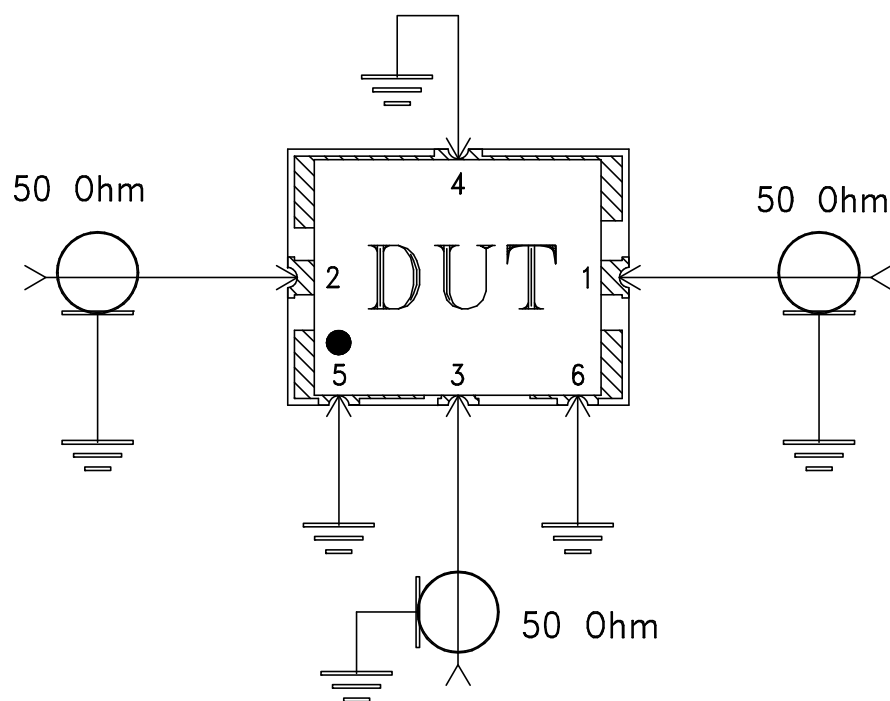
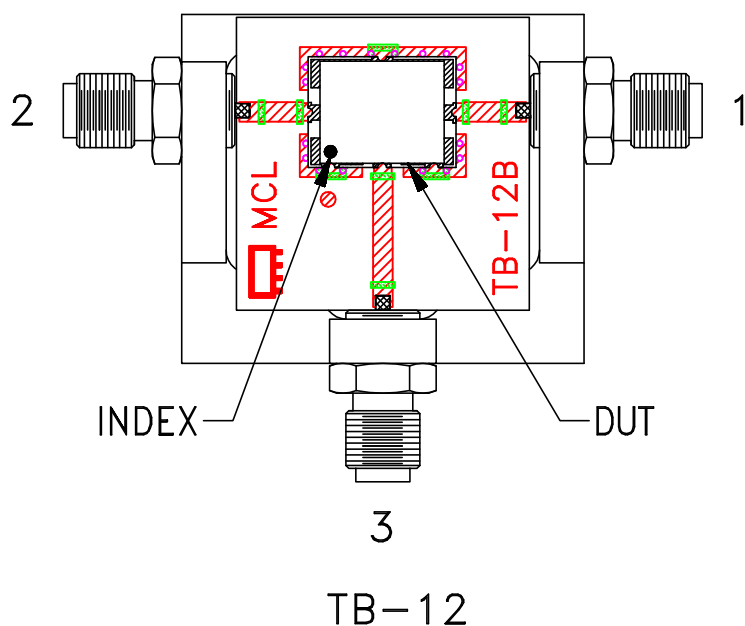
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ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit

For Pin Connections Refer to Data Sheet of the DUT



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215